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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, Temp Sensor, WDT
Number of I/O	23
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f042ahj020ec

Table 1. Z8 Encore! XP® F082A Series Family Part Selection Guide

Part Number	Flash (KB)	RAM (B)	NVDS[1] (B)	I/O	Comparator	Advanced Analog[2]	ADC Inputs	Packages
Z8F082A	8	1024	0	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F081A	8	1024	0	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F042A	4	1024	128	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F041A	4	1024	128	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F022A	2	512	64	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F021A	2	512	64	6–25	Yes	No	0	8-, 20- and 28-pin
Z8F012A	1	256	16	6–23	Yes	Yes	4–8	8-, 20- and 28-pin
Z8F011A	1	256	16	6–25	Yes	No	0	8-, 20- and 28-pin

[1]Non-volatile data storage.
[2]Advanced Analog includes ADC, temperature sensor, and low-power operational amplifier.

Table 7. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No
F0B	Timer 1 Reload Low Byte	T1RL	FF	88
F0C	Timer 1 PWM High Byte	T1PWMH	00	88
F0D	Timer 1 PWM Low Byte	T1PWML	00	89
F0E	Timer 1 Control 0	T1CTL0	00	83
F0F	Timer 1 Control 1	T1CTL1	00	84
F10–F6F	Reserved	—	XX	
UART				
F40	UART Transmit/Receive Data Registers	TXD, RXD	XX	113
F41	UART Status 0 Register	U0STAT0	00	111
F42	UART Control 0 Register	U0CTL0	00	108
F43	UART Control 1 Register	U0CTL1	00	108
F44	UART Status 1 Register	U0STAT1	00	112
F45	UART Address Compare Register	U0ADDR	00	114
F46	UART Baud Rate High Byte Register	U0BRH	FF	114
F47	UART Baud Rate Low Byte Register	U0BRL	FF	114
Analog-to-Digital Converter (ADC)				
F70	ADC Control 0	ADCCTL0	00	130
F71	ADC Control 1	ADCCTL1	80	130
F72	ADC Data High Byte	ADCD_H	XX	133
F73	ADC Data Low Bits	ADCD_L	XX	133
F74–F7F	Reserved	—	XX	
Low Power Control				
F80	Power Control 0	PWRCTL0	80	35
F81	Reserved	—	XX	
LED Controller				
F82	LED Drive Enable	LEDEN	00	52
F83	LED Drive Level High Byte	LEDLVLH	00	53
F84	LED Drive Level Low Byte	LEDLVLL	00	54
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator Control	OSCCTL	A0	190
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 Control	CMP0	14	136

XX=Undefined

vector address. Following Stop Mode Recovery, the STOP bit in the Reset Status (RSTSTAT) Register is set to 1. Table 10 lists the Stop Mode Recovery sources and resulting actions. The text following provides more detailed information about each of the Stop Mode Recovery sources.

Table 10. Stop Mode Recovery Sources and Resulting Action

Operating Mode	Stop Mode Recovery Source	Action
STOP mode	Watchdog Timer time-out when configured for Reset	Stop Mode Recovery
	Watchdog Timer time-out when configured for interrupt	Stop Mode Recovery followed by interrupt (if interrupts are enabled)
	Data transition on any GPIO Port pin enabled as a Stop Mode Recovery source	Stop Mode Recovery
	Assertion of external $\overline{\text{RESET}}$ Pin	System Reset
	Debug Pin driven Low	System Reset

Stop Mode Recovery Using Watchdog Timer Time-Out

If the Watchdog Timer times out during STOP mode, the device undergoes a Stop Mode Recovery sequence. In the Reset Status (RSTSTAT) register, the WDT and STOP bits are set to 1. If the Watchdog Timer is configured to generate an interrupt upon time-out and the Z8 Encore! XP F082A Series device is configured to respond to interrupts, the eZ8 CPU services the Watchdog Timer interrupt request following the normal Stop Mode Recovery sequence.

Stop Mode Recovery Using a GPIO Port Pin Transition

Each of the GPIO Port pins may be configured as a Stop Mode Recovery input source. On any GPIO pin enabled as a Stop Mode Recovery source, a change in the input pin value (from High to Low or from Low to High) initiates Stop Mode Recovery.

Note: *The SMR pulses shorter than specified does not trigger a recovery (see Table 131 on page 229). When this happens, the STOP bit in the Reset Status (RSTSTAT) register is set to 1.*

Caution: *In STOP mode, the GPIO Port Input Data registers (PxIN) are disabled. The Port Input Data registers record the Port transition only if the signal stays on the Port pin through the end of the Stop Mode Recovery delay. As a result, short pulses on the Port pin can*

initiate Stop Mode Recovery without being written to the Port Input Data register or without initiating an interrupt (if enabled for that pin).

Stop Mode Recovery Using the External $\overline{\text{RESET}}$ Pin

When the Z8 Encore! XP F082A Series device is in STOP mode and the external $\overline{\text{RESET}}$ pin is driven Low, a system reset occurs. Because of a glitch filter operating on the $\overline{\text{RESET}}$ pin, the Low pulse must be greater than the minimum width specified, or it is ignored. See Electrical Characteristics on page 221 for details.

Low Voltage Detection

In addition to the Voltage Brownout (VBO) Reset described above, it is also possible to generate an interrupt when the supply voltage drops below a user-selected value. For details about configuring the Low Voltage Detection (LVD) and the threshold levels available, see Trim Bit Address 0003H on page 159. The LVD function is available on the 8-pin product versions only.

When the supply voltage drops below the LVD threshold, the LVD bit of the Reset Status (RSTSTAT) register is set to one. This bit remains one until the low-voltage condition goes away. Reading or writing this bit does not clear it. The LVD circuit can also generate an interrupt when so enabled, see Interrupt Vectors and Priority on page 58. The LVD bit is NOT latched, so enabling the interrupt is the only way to guarantee detection of a transient low voltage event.

The LVD functionality depends on circuitry shared with the VBO block; therefore, disabling the VBO also disables the LVD.

Reset Register Definitions

The following sections define the Reset registers.

Reset Status Register

The Reset Status (RSTSTAT) register is a read-only register that indicates the source of the most recent Reset event, indicates a Stop Mode Recovery event, and indicates a Watchdog Timer time-out. Reading this register resets the upper four bits to 0.

This register shares its address with the Watchdog Timer control register, which is write-only (see Table 11 on page 31).

WDT Reset in Normal Operation

If configured to generate a Reset when a time-out occurs, the Watchdog Timer forces the device into the System Reset state. The WDT status bit in the Reset Status (RSTSTAT) register is set to 1. For more information on system reset, see Reset, Stop Mode Recovery, and Low Voltage Detection on page 23.

WDT Reset in STOP Mode

If configured to generate a Reset when a time-out occurs and the device is in STOP mode, the Watchdog Timer initiates a Stop Mode Recovery. Both the WDT status bit and the STOP bit in the Reset Status (RSTSTAT) register are set to 1 following WDT time-out in STOP mode.

Watchdog Timer Reload Unlock Sequence

Writing the unlock sequence to the Watchdog Timer (WDTCTL) Control register address unlocks the three Watchdog Timer Reload Byte registers (WDTU, WDTH, and WDTL) to allow changes to the time-out period. These write operations to the WDTCTL register address produce no effect on the bits in the WDTCTL register. The locking mechanism prevents spurious writes to the Reload registers. Follow the steps below to unlock the Watchdog Timer Reload Byte registers (WDTU, WDTH, and WDTL) for write access.

1. Write 55H to the Watchdog Timer Control register (WDTCTL).
2. Write AAH to the Watchdog Timer Control register (WDTCTL).
3. Write the Watchdog Timer Reload Upper Byte register (WDTU) with the desired time-out value.
4. Write the Watchdog Timer Reload High Byte register (WDTH) with the desired time-out value.
5. Write the Watchdog Timer Reload Low Byte register (WDTL) with the desired time-out value.

All three Watchdog Timer Reload registers must be written in the order just listed. There must be no other register writes between each of these operations. If a register write occurs, the lock state machine resets and no further writes can occur unless the sequence is restarted. The value in the Watchdog Timer Reload registers is loaded into the counter when the Watchdog Timer is first enabled and every time a WDT instruction is executed.

Watchdog Timer Calibration

Due to its extremely low operating current, the Watchdog Timer oscillator is somewhat inaccurate. This variation can be corrected using the calibration data stored in the Flash Information Page (see Table 97 and Table 98 on page 165). Loading these values into the

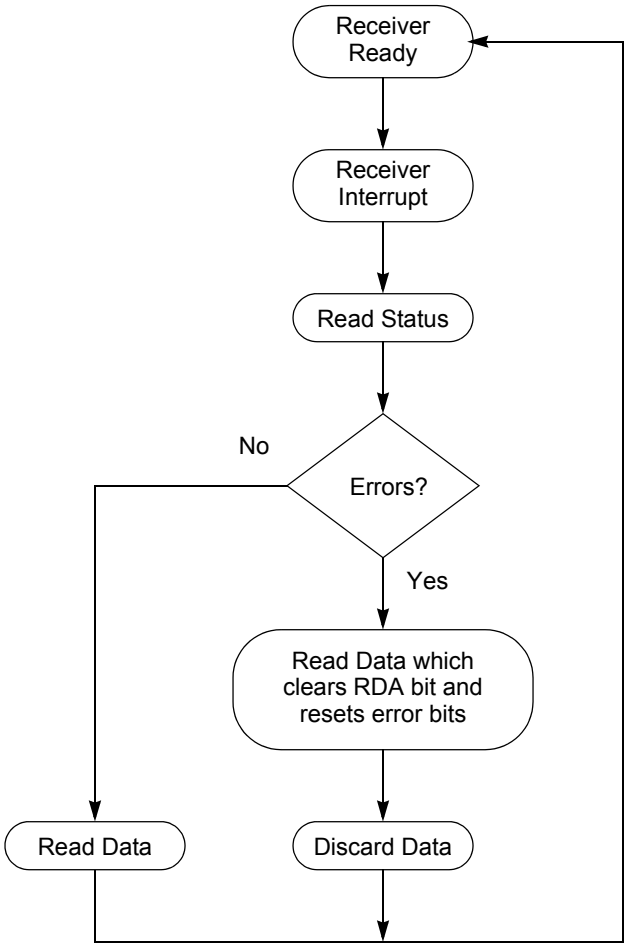

Figure 15. UART Receiver Interrupt Service Routine Flow

Baud Rate Generator Interrupts

If the baud rate generator (BRG) interrupt enable is set, the UART Receiver interrupt asserts when the UART Baud Rate Generator reloads. This condition allows the Baud Rate Generator to function as an additional counter if the UART functionality is not employed.

UART Baud Rate Generator

The UART Baud Rate Generator creates a lower frequency baud rate clock for data transmission. The input to the Baud Rate Generator is the system clock. The UART Baud Rate High and Low Byte registers combine to create a 16-bit baud rate divisor value

MPRX—Multiprocessor Receive
Returns the value of the most recent multiprocessor bit received. Reading from the UART Receive Data register resets this bit to 0.

UART Transmit Data Register

Data bytes written to the UART Transmit Data (UxTXD) register (Table 65) are shifted out on the TXDx pin. The Write-only UART Transmit Data register shares a Register File address with the read-only UART Receive Data register.

Table 65. UART Transmit Data Register (U0TXD)

BITS	7	6	5	4	3	2	1	0
FIELD	TXD							
RESET	X	X	X	X	X	X	X	X
R/W	W	W	W	W	W	W	W	W
ADDR	F40H							

TXD—Transmit Data
UART transmitter data byte to be shifted out through the TXD*x* pin.

UART Receive Data Register

Data bytes received through the RXD*x* pin are stored in the UART Receive Data (UxRXD) register (Table 66). The read-only UART Receive Data register shares a Register File address with the Write-only UART Transmit Data register.

Table 66. UART Receive Data Register (U0RXD)

BITS	7	6	5	4	3	2	1	0
FIELD	RXD							
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
ADDR	F40H							
X = Undefined.								

RXD—Receive Data
UART receiver data byte from the RXD*x* pin

Caution: *Although the ADC can be used without the gain and offset compensation, it does exhibit non-unity gain. Designing the ADC with sub-unity gain reduces noise across the ADC range but requires the ADC results to be scaled by a factor of 8/7.*

ADC Compensation Details

High efficiency assembly code that performs this compensation is available for download on www.zilog.com. The following is a bit-specific description of the ADC compensation process used by this code.

The following data bit definitions are used:

0-9, a-f = bit indices in hexadecimal
s = sign bit
v = overflow bit
- = unused

Input Data

MSB	LSB	
s b a 9 8 7 6 5	4 3 2 1 0 - - v (ADC)	ADC Output Word; if v = 1, the data is invalid
	s 6 5 4 3 2 1 0	Offset Correction Byte
s s s s s 7 6 5	4 3 2 1 0 0 0 0 (Offset)	Offset Byte shifted to align with ADC data
s e d c b a 9 8	7 6 5 4 3 2 1 0 (Gain)	Gain Correction Word

Table 104. NVDS Read Time (Continued)

Operation	Minimum Latency	Maximum Latency
Read (128 byte array)	883	7609
Write (16 byte array)	4973	5009
Write (64 byte array)	4971	5013
Write (128 byte array)	4984	5023
Illegal Read	43	43
Illegal Write	31	31

If NVDS read performance is critical to your software architecture, there are some things you can do to optimize your code for speed, listed in order from most helpful to least helpful:

- Periodically refresh all addresses that are used. The optimal use of NVDS in terms of speed is to rotate the writes evenly among all addresses planned to use, bringing all reads closer to the minimum read time. Because the minimum read time is much less than the write time, however, actual speed benefits are not always realized.
- Use as few unique addresses as possible: this helps to optimize the impact of refreshing as well as minimize the requirement for it.

High. Because of the open-drain nature of the DBG pin, the host can send a Serial Break to the OCD even if the OCD is transmitting a character.

OCD Unlock Sequence (8-Pin Devices Only)

Because of pin-sharing on the 8-pin device, an unlock sequence must be performed to access the DBG pin. If this sequence is not completed during a system reset, then the PA0/DBG pin functions only as a GPIO pin.

The following sequence unlocks the DBG pin:

1. Hold PA2/$\overline{\text{RESET}}$ Low.
2. Wait 5ms for the internal reset sequence to complete.
3. Send the following bytes serially to the debug pin:

```
DBG ← 80H (autobaud)
DBG ← EBH
DBG ← 5AH
DBG ← 70H
DBG ← CDH (32-bit unlock key)
```

4. Release PA2/$\overline{\text{RESET}}$. The PA0/DBG pin is now identical in function to that of the DBG pin on the 20-/28-pin device. To enter DEBUG mode, re-autobaud and write 80H to the OCD control register (see On-Chip Debugger Commands on page 179).

Caution: *Between Step 3 and Step 4, there is an interval during which the 8-pin device is neither in RESET nor DEBUG mode. If a device has been erased or has not yet been programmed, all program memory bytes contain FFH. The CPU interprets this as an illegal instruction, so some irregular behavior can occur before entering DEBUG mode, and the register values after entering DEBUG mode differs from their specified reset values. However, none of these irregularities prevent programming the Flash memory. Before beginning system debug, it is recommended that some legal code be programmed into the 8-pin device, and that a RESET occurs.*

Breakpoints

Execution Breakpoints are generated using the BRK instruction (opcode 00H). When the eZ8 CPU decodes a BRK instruction, it signals the On-Chip Debugger. If Breakpoints are enabled, the OCD enters DEBUG mode and idles the eZ8 CPU. If Breakpoints are not enabled, the OCD ignores the BRK signal and the BRK instruction operates as an NOP instruction.

Oscillator Control

The Z8 Encore! XP® F082A Series devices uses five possible clocking schemes, each user-selectable:

- Internal precision trimmed RC oscillator (IPO).
- On-chip oscillator using off-chip crystal or resonator.
- On-chip oscillator using external RC network.
- External clock drive.
- On-chip low power Watchdog Timer oscillator.
- Clock failure detection circuitry.

In addition, Z8 Encore! XP F082A Series devices contain clock failure detection and recovery circuitry, allowing continued operation despite a failure of the system clock oscillator.

Operation

This chapter discusses the logic used to select the system clock and handle primary oscillator failures.

System Clock Selection

The oscillator control block selects from the available clocks. Table 108 details each clock source and its usage.

Crystal Oscillator

The products in the Z8 Encore! XP® F082A Series contain an on-chip crystal oscillator for use with external crystals with 32 kHz to 20 MHz frequencies. In addition, the oscillator supports external RC networks with oscillation frequencies up to 4 MHz or ceramic resonators with frequencies up to 8 MHz. The on-chip crystal oscillator can be used to generate the primary system clock for the internal eZ8 CPU and the majority of the on-chip peripherals. Alternatively, the X_{IN} input pin can also accept a CMOS-level clock input signal (32 kHz–20 MHz). If an external clock generator is used, the X_{OUT} pin must be left unconnected. The Z8 Encore! XP F082A Series products do not contain an internal clock divider. The frequency of the signal on the X_{IN} input pin determines the frequency of the system clock.

Note: *Although the XIN pin can be used as an input for an external clock generator, the CLKIN pin is better suited for such use (see* System Clock Selection *on page 187**).*

Operating Modes

The Z8 Encore! XP F082A Series products support four oscillator modes:

- Minimum power for use with very low frequency crystals (32 kHz–1 MHz).
- Medium power for use with medium frequency crystals or ceramic resonators (0.5 MHz to 8 MHz).
- Maximum power for use with high frequency crystals (8 MHz to 20 MHz).
- On-chip oscillator configured for use with external RC networks (<4 MHz).

The oscillator mode is selected using user-programmable Flash Option Bits. See Flash Option Bits on page 153 for information.

Crystal Oscillator Operation

The Flash Option bit XTLDIS controls whether the crystal oscillator is enabled during reset. The crystal may later be disabled after reset if a new oscillator has been selected as the system clock. If the crystal is manually enabled after reset through the OSCCTL register, the user code must wait at least 1000 crystal oscillator cycles for the crystal to stabilize. After this, the crystal oscillator may be selected as the system clock.

Note: *The stabilization time varies depending on the crystal or resonator used, as well as on the feedback network. See* Table 111 *for transconductance values to compute oscillator stabilization times.*

Figure 29 displays the typical (3.3 V and 25 °C) oscillator frequency as a function of the capacitor (*C* in pF) employed in the RC network assuming a 45 KΩ external resistor. For very small values of C, the parasitic capacitance of the oscillator XIN pin and the printed circuit board must be included in the estimation of the oscillator frequency.

It is possible to operate the RC oscillator using only the parasitic capacitance of the package and printed circuit board. To minimize sensitivity to external parasitics, external capacitance values in excess of 20 pF are recommended.

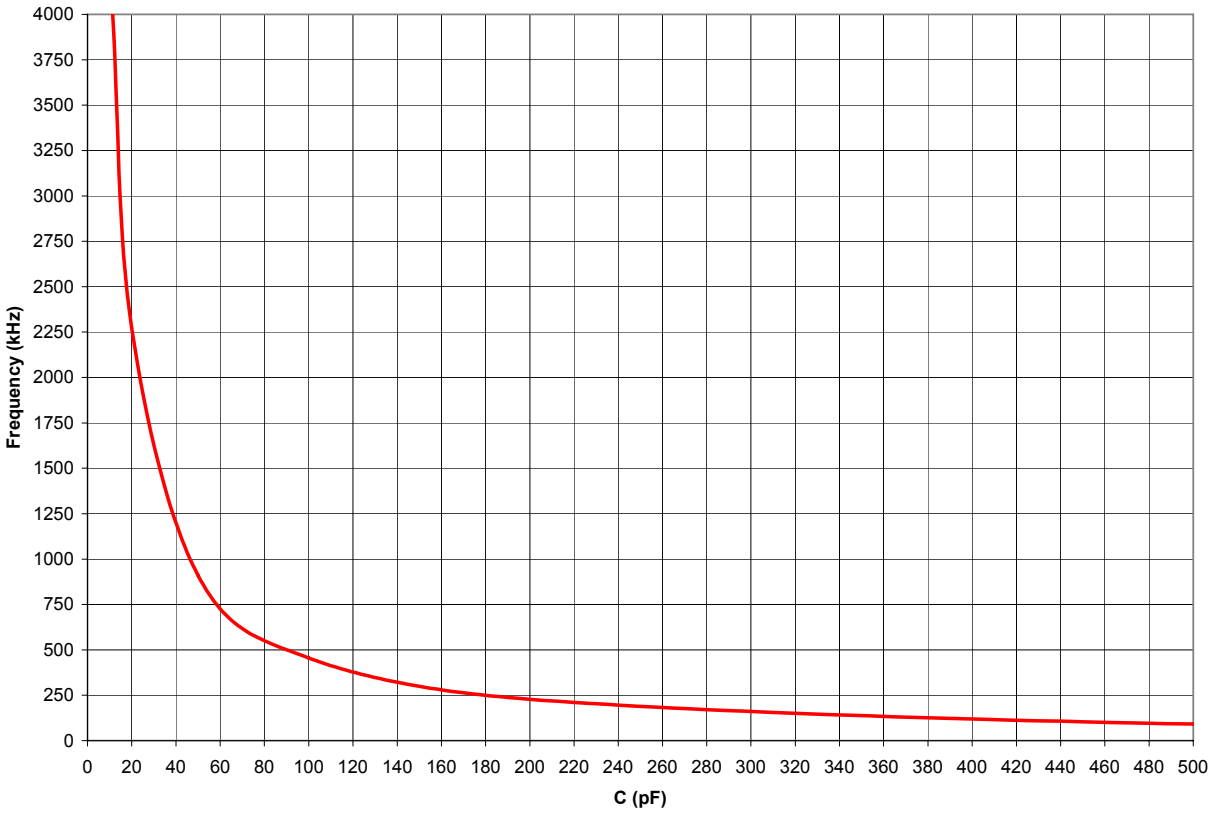

Figure 29. Typical RC Oscillator Frequency as a Function of the External Capacitance with a 45 kΩ Resistor

Caution: *When using the external RC oscillator mode, the oscillator can stop oscillating if the power supply drops below 2.7 V, but before the power supply drops to the Voltage Brownout threshold. The oscillator resumes oscillation when the supply voltage exceeds 2.7 V.*

Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
SUBX dst, src	dst ← dst – src	ER	ER	28	*	*	*	*	1	*	4	3
		ER	IM	29							4	3
SWAP dst	dst[7:4] ↔ dst[3:0]	R		F0	X	*	*	X	–	–	2	2
		IR		F1							2	3
TCM dst, src	(NOT dst) AND src	r	r	62	–	*	*	0	–	–	2	3
		r	Ir	63							2	4
		R	R	64							3	3
		R	IR	65							3	4
		R	IM	66							3	3
		IR	IM	67							3	4
TCMX dst, src	(NOT dst) AND src	ER	ER	68	–	*	*	0	–	–	4	3
		ER	IM	69							4	3
TM dst, src	dst AND src	r	r	72	–	*	*	0	–	–	2	3
		r	Ir	73							2	4
		R	R	74							3	3
		R	IR	75							3	4
		R	IM	76							3	3
		IR	IM	77							3	4
TMX dst, src	dst AND src	ER	ER	78	–	*	*	0	–	–	4	3
		ER	IM	79							4	3
TRAP Vector	SP ← SP – 2 @SP ← PC SP ← SP – 1 @SP ← FLAGS PC ← @Vector		Vector	F2	–	–	–	–	–	–	2	6
WDT				5F	–	–	–	–	–	–	1	2
Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined				0 = Reset to 0 1 = Set to 1							

Table 134. Non-Volatile Data Storage

	V_{DD} = 2.7 V to 3.6 V T_A = -40 °C to +105 °C				
Parameter	**Minimum**	**Typical**	**Maximum**	**Units**	**Notes**
NVDS Byte Read Time	34	–	519	µs	With system clock at 20 MHz
NVDS Byte Program Time	0.171	–	39.7	ms	With system clock at 20 MHz
Data Retention	100	–	–	years	25 °C
Endurance	160,000	–	–	cycles	Cumulative write cycles for entire memory

Table 135. Analog-to-Digital Converter Electrical Characteristics and Timing

		V_{DD} = 3.0 V to 3.6 V T_A = 0 °C to +70 °C (unless otherwise stated)				
Symbol	**Parameter**	**Minimum**	**Typical**	**Maximum**	**Units**	**Conditions**
	Resolution	10		–	bits	
	Differential Nonlinearity (DNL)	-1.0	–	1.0	LSB[3]	External V_{REF} = 2.0 V; $R_S \leftarrow$ 3.0 kΩ
	Integral Nonlinearity (INL)	-3.0	–	3.0	LSB[3]	External V_{REF} = 2.0 V; $R_S \leftarrow$ 3.0 kΩ
	Offset Error with Calibration		±1		LSB[3]	
	Absolute Accuracy with Calibration		±3		LSB[3]	
V_{REF}	Internal Reference Voltage	1.0 2.0	1.1 2.2	1.2 2.4	V	REFSEL=01 REFSEL=10
V_{REF}	Internal Reference Variation with Temperature		±1.0		%	Temperature variation with V_{DD} = 3.0
V_{REF}	Internal Reference Voltage Variation with V_{DD}		±0.5		%	Supply voltage variation with T_A = 30 °C
R_{REFOUT}	Reference Buffer Output Impedance		850		Ω	When the internal reference is buffered and driven out to the VREF pin (REFOUT = 1)

Part Number	Flash	RAM	NVDS	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Comparator	Temperature Sensor	Description
Z8 Encore! XP® F082A Series with 2 KB Flash											
Standard Temperature: 0 °C to 70 °C											
Z8F021APB020SC	2 KB	512 B	64 B	6	13	2	0	1	1	0	PDIP 8-pin package
Z8F021AQB020SC	2 KB	512 B	64 B	6	13	2	0	1	1	0	QFN 8-pin package
Z8F021ASB020SC	2 KB	512 B	64 B	6	13	2	0	1	1	0	SOIC 8-pin package
Z8F021ASH020SC	2 KB	512 B	64 B	17	19	2	0	1	1	0	SOIC 20-pin package
Z8F021AHH020SC	2 KB	512 B	64 B	17	19	2	0	1	1	0	SSOP 20-pin package
Z8F021APH020SC	2 KB	512 B	64 B	17	19	2	0	1	1	0	PDIP 20-pin package
Z8F021ASJ020SC	2 KB	512 B	64 B	25	19	2	0	1	1	0	SOIC 28-pin package
Z8F021AHJ020SC	2 KB	512 B	64 B	25	19	2	0	1	1	0	SSOP 28-pin package
Z8F021APJ020SC	2 KB	512 B	64 B	25	19	2	0	1	1	0	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C											
Z8F021APB020EC	2 KB	512 B	64 B	6	13	2	0	1	1	0	PDIP 8-pin package
Z8F021AQB020EC	2 KB	512 B	64 B	6	13	2	0	1	1	0	QFN 8-pin package
Z8F021ASB020EC	2 KB	512 B	64 B	6	13	2	0	1	1	0	SOIC 8-pin package
Z8F021ASH020EC	2 KB	512 B	64 B	17	19	2	0	1	1	0	SOIC 20-pin package
Z8F021AHH020EC	2 KB	512 B	64 B	17	19	2	0	1	1	0	SSOP 20-pin package
Z8F021APH020EC	2 KB	512 B	64 B	17	19	2	0	1	1	0	PDIP 20-pin package
Z8F021ASJ020EC	2 KB	512 B	64 B	25	19	2	0	1	1	0	SOIC 28-pin package
Z8F021AHJ020EC	2 KB	512 B	64 B	25	19	2	0	1	1	0	SSOP 28-pin package
Z8F021APJ020EC	2 KB	512 B	64 B	25	19	2	0	1	1	0	PDIP 28-pin package
Replace C with G for Lead-Free Packaging											

G

H

I

J

Customer Support

For answers to technical questions about the product, documentation, or any other issues with Zilog's offerings, please visit Zilog's Knowledge Base at http://www.zilog.com/kb.

For any comments, detail technical questions, or reporting problems, please visit Zilog's Technical Support at http://support.zilog.com.